

ASMT-Jx33

3W Mini Power LED Light Source



Data Sheet



Lead (Pb) Free
RoHS 6 fully
compliant



Description

The 3W Mini Power LED Light Source is a high performance energy efficient device which delivers high flux output and possesses high color rendering index. This device can handle high driving current. Option with electrically isolated metal slug is also available.

The White Mini Power LED is available in the range of color temperature from 2700K to 10000K.

The low profile package design and ultra small footprint is suitable for a wide variety of applications especially where space and height is a constraint.

The package is compatible with reflow soldering process. To facilitate easy pick & place assembly, the LEDs are packed in EIA-compliant tape and reel.

Features

- High Color Rendering Index (CRI)
- Available in Cool White, Neutral White and Warm White
- Small footprint and low profile
- Symmetrical outline
- Energy efficient
- Direct heat transfer from metal slug to mother board
- Compatible with reflow soldering process
- High current operation
- Long operation life
- Wide viewing angle
- Silicone encapsulation
- Non-ESD sensitive (threshold > 16kV)
- MSL 1 products

Applications

- Retail lighting
- Display case lighting
- Security lighting
- Commercial lighting such as window decorative lighting in shopping malls
- Architectural lighting

CAUTION: Customer is advised to keep the LEDs in the MBB when not in use as prolonged exposure to environment might cause the silver plated leads to tarnish, which might cause difficulties in soldering.

Package Dimensions

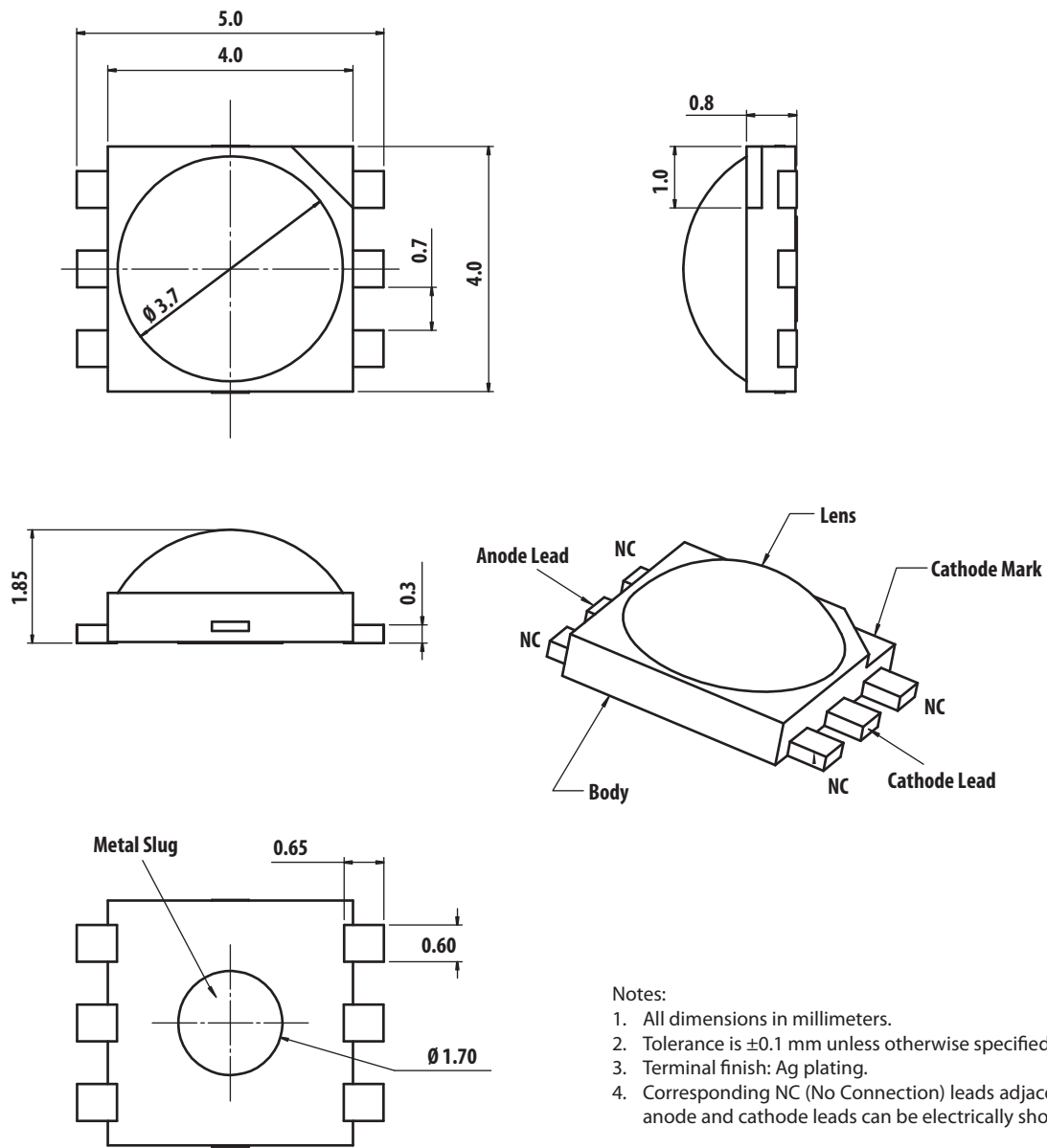
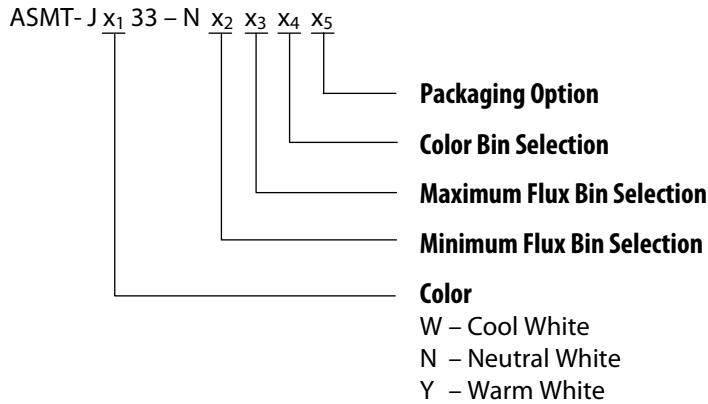


Figure 1. ASMT-Jx33 package outline drawing

Part Numbering System



Note:

1. Please refer to Page 7 for selection details.

Device Selection Guide (T_J = 25°C)

Part Number	Color	Luminous Flux (lm), $\Phi_V^{[1,2]}$			Test Current (mA)	Dice Technology	Electrically Isolated Metal Slug
		Min.	Typ.	Max.			
ASMT-JW33-NSU01	Cool White	51.7	70.0	99.6	350	InGaN	Yes
ASMT-JW33-NUV01		87.4	100.0	113.6	350	InGaN	Yes
ASMT-JN33-NSU01	Neutral White	51.7	70.0	99.6	350	InGaN	Yes
ASMT-JN33-NUV01		87.4	100.0	113.6	350	InGaN	Yes
ASMT-JY33-NQS01	Warm White	30.6	45.0	67.2	350	InGaN	Yes
ASMT-JY33-NRS01		39.8	60.0	67.2	350	InGaN	Yes
ASMT-JY33-NSTJ1		51.7	70.0	87.4	350	InGaN	Yes

Notes:

1. Φ_V is the total luminous flux output as measured with an integrating sphere at 25ms mono pulse condition.
2. Flux tolerance is $\pm 10\%$

Absolute Maximum Ratings

Parameter	InGaN	Units
DC Forward Current ^[1]	700	mA
Peak Pulsing Current	2400	mA
Power Dissipation	2730	mW
LED Junction Temperature	135	°C
Operating Metal Slug Temperature Range at 350 mA	-40 to +120	°C
Operating Metal Slug Temperature Range at 700 mA	-40 to +105	°C
Storage Temperature Range	-40 to +120	°C
Soldering Temperature	Refer to Figure 14	
Reverse Voltage ^[2]	Not recommended	

Notes:

1. Derate linearly based on Figure 10.
2. Not designed for reverse bias operation.

Optical Characteristics at 350 mA ($T_J = 25^\circ\text{C}$)

Part Number	Color	Correlated Color Temperature, CCT (Kelvin)		Viewing Angle, $2\theta_{1/2}$ [1] (°)	Luminous Efficiency (lm/W)	Color Rendering Index, CRI
		Min.	Max.	Typ.	Typ.	Typ.
ASMT-JW33-NSU01	Cool White	4500	10000	140	63	80
ASMT-JW33-NUV01		4500	10000	140	89	80
ASMT-JN33-NSU01	Neutral White	3500	4500	140	63	80
ASMT-JN33-NUV01		3500	4500	140	89	80
ASMT-JY33-NQS01	Warm White	2700	3500	140	40	90
ASMT-JY33-NRS01		2700	3500	140	54	90
ASMT-JY33-NSTJ1		2850	3250	140	63	85

Note:

1. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is $\frac{1}{2}$ the peak intensity.

Electrical Characteristic at 350 mA ($T_J = 25^\circ\text{C}$)

Dice Type	Forward Voltage, V_F (Volts)			Thermal Resistance, $R_{\theta_{J-MS}}$ (°C/W) [1]
	Min.	Typ	Max.	Typ.
InGaN	2.8	3.2	3.5	9

Note:

1. $R_{\theta_{J-MS}}$ is Thermal Resistance from LED junction to metal slug.

Optical and Electrical Characteristic at 700 mA ($T_J = 25^\circ\text{C}$)

Part Number	Color	Luminous Flux (lm), Φ_V	Forward Voltage, V_F (Volts)
		Typ.	Typ.
ASMT-JW33-NSU01	Cool White	125.0	3.6
ASMT-JW33-NUV01		178.0	3.6
ASMT-JN33-NSU01	Neutral White	125.0	3.6
ASMT-JN33-NUV01		178.0	3.6
ASMT-JY33-NQS01	Warm White	80.0	3.6
ASMT-JY33-NRS01		107.0	3.6
ASMT-JY33-NSTJ1		125.0	3.6

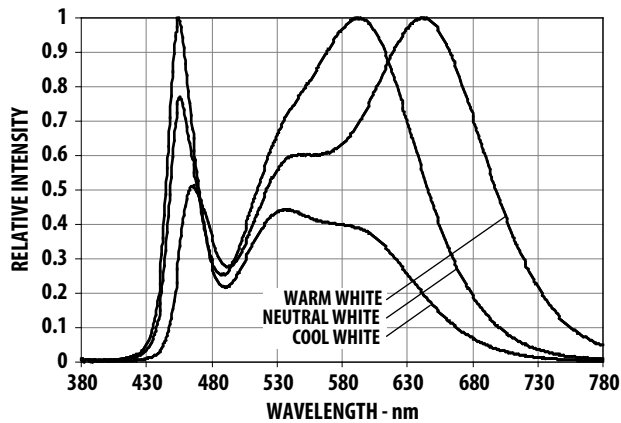


Figure 2. Relative Intensity vs. Wavelength for Cool White and Warm White

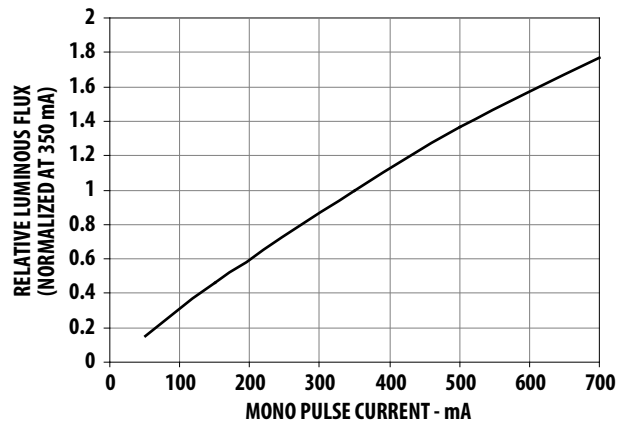


Figure 3. Relative Luminous Flux vs. Mono Pulse Current

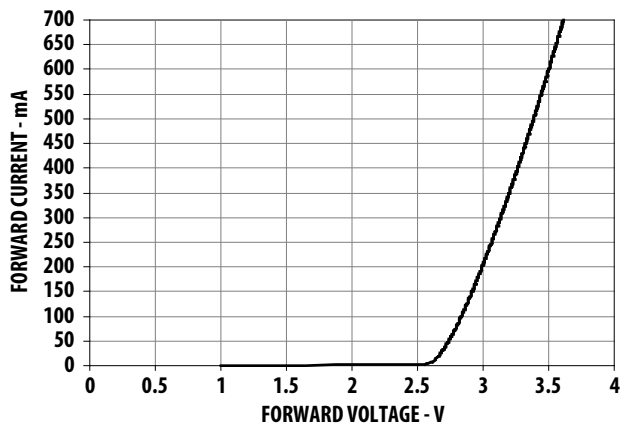


Figure 4. Forward Current vs. Forward Voltage

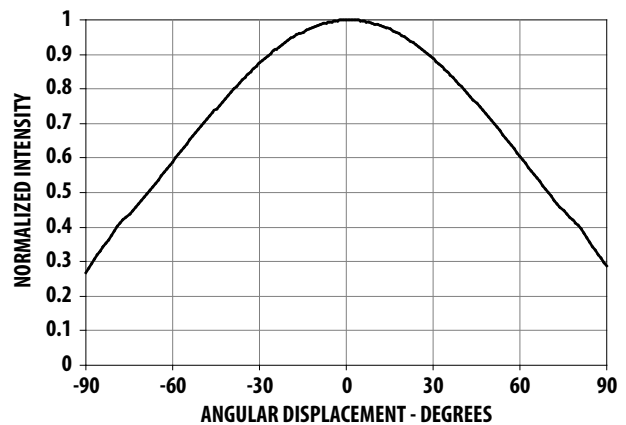


Figure 5. Radiation Pattern for Cool White, Warm White and Neutral White

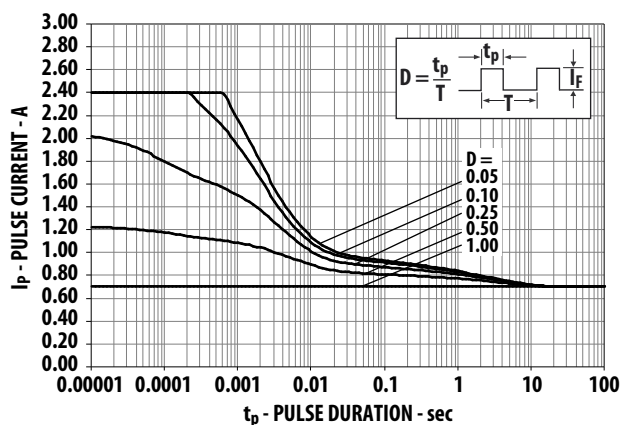


Figure 6. Maximum pulse current vs. pulse duration. Derated based on $T_A = 25^\circ\text{C}$, $R_{\theta JA} = 30^\circ\text{C/W}$.

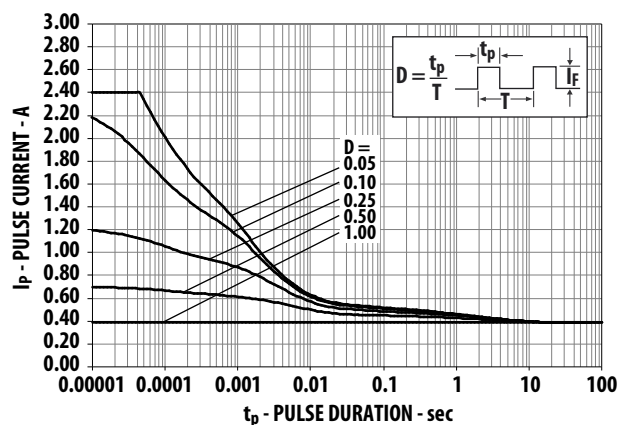


Figure 7. Maximum pulse current vs. pulse duration. Derated based on $T_A = 85^\circ\text{C}$, $R_{\theta JA} = 30^\circ\text{C/W}$.

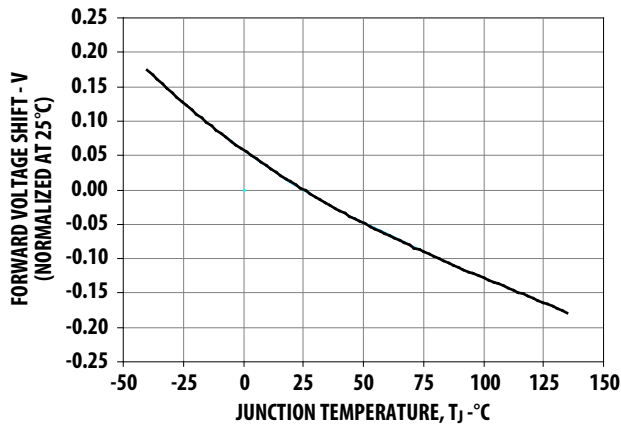


Figure 8. Relative Light Output vs. Junction Temperature

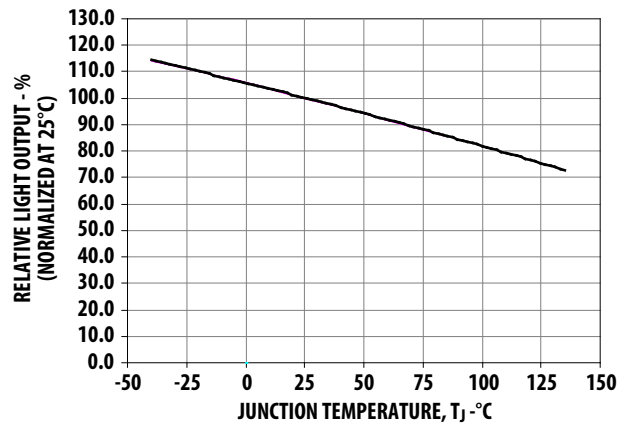


Figure 9. Forward Voltage Shift vs. Junction Temperature

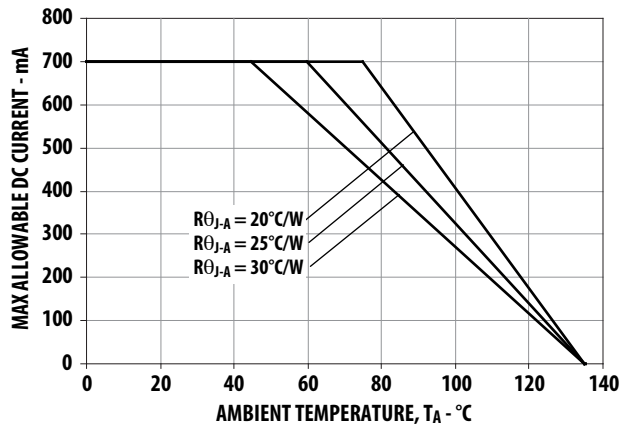


Figure 10. Maximum Forward Current vs. Ambient Temperature. Derated based on $T_{JMAX} = 125^\circ\text{C}$, $R_{\theta JA} = 20^\circ\text{C/W}$, 25°C/W and 30°C/W

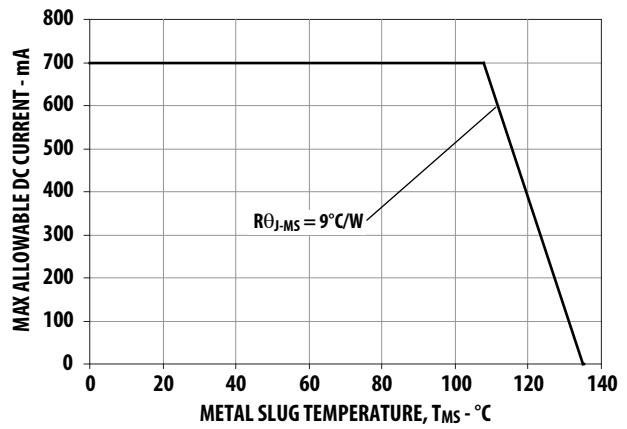


Figure 11. Maximum Forward Current vs. Metal Slug Temperature. Derated based on $T_{JMAX} = 125^\circ\text{C}$, $R_{\theta MS} = 9^\circ\text{C/W}$

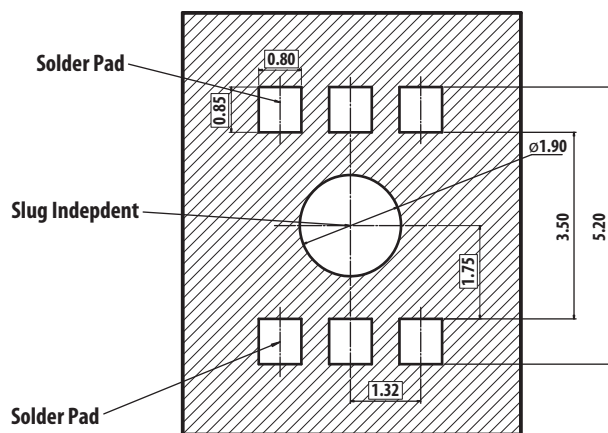


Figure 12. Recommended soldering land pattern

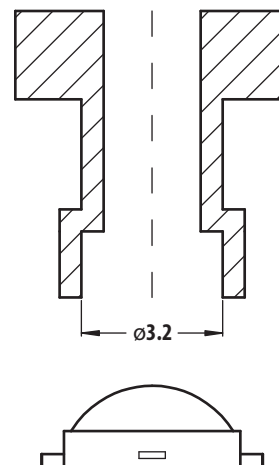


Figure 13. Recommended pick and place nozzle tip. Inner diameter = 3.2 mm

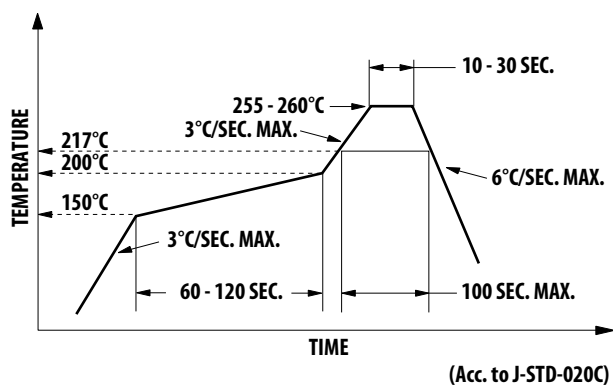


Figure 14. Recommended Reflow Soldering Profile

Note:

For detail information on reflow soldering of Avago surface mount LEDs, do refer to Avago Application Note AN1060 Surface Mounting SMT LED Indicator Components.

Option Selection Details

ASMT-J x₁ 33 – N x₂ x₃ x₄ x₅

x₂ – Minimum Flux Bin Selection

x₃ – Maximum Flux Bin Selection

x₄ – Color Bin Selection

x₅ – Packaging Option

Flux Bin Limit [x₂, x₃]

Bin ID	Luminous Flux (lm) at 350 mA	
	Min.	Max.
Q	30.6	39.8
R	39.8	51.7
S	51.7	67.2
T	67.2	87.4
U	87.4	99.6
V	99.6	113.6
W	113.6	129.5

Tolerance for each bin limits is ±10%

Color Bin Selection [x₄]

Individual reel will contain parts from one color bin selection only.

Cool White

Selection	Bin ID
0	Full Distribution
H	UN, VN, U0 and V0
J	WN, VN, W0 and V0
K	XN, WN, X0 and W0
P	Y0

Warm White

Selection	Bin ID
0	Full Distribution
H	M1, N1, M0 and N0
J	P1, N1, P0 and N0
K	Q1, P1, Q0 and P0

Neutral White

Selection	Bin ID
0	Full Distribution
G	S1, R1, S0 and R0
H	TN, S1, T0 and S0

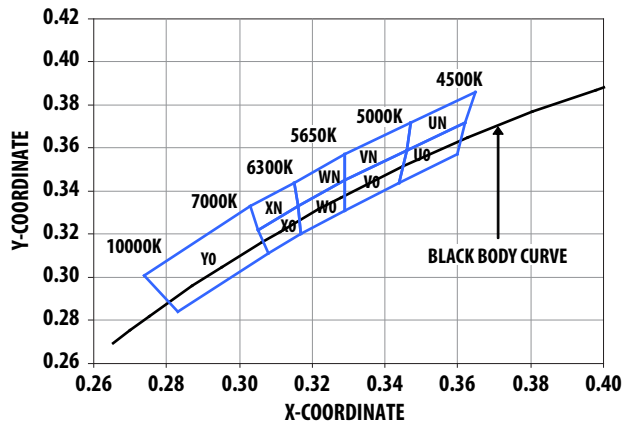


Figure 15. Color bin Structure for Cool White

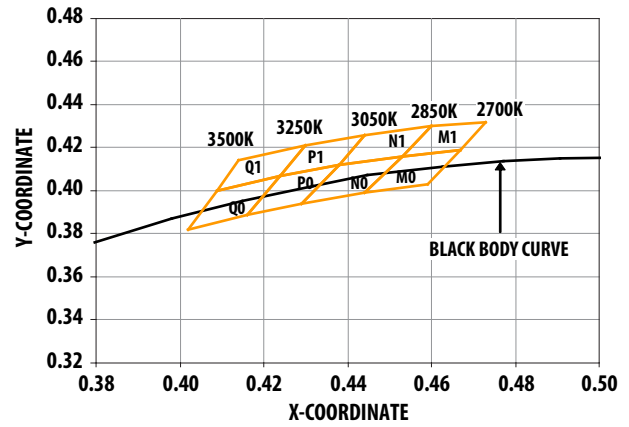


Figure 16. Color bin structure for Warm White

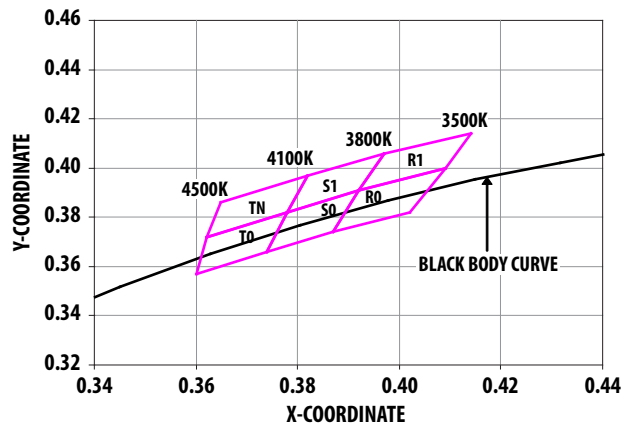


Figure 17. Color bin structure for Neutral White

Color Bin Limits

Cool White	Color Limits (Chromaticity Coordinates)				
Bin UN	x	0.365	0.362	0.346	0.347
	y	0.386	0.372	0.359	0.372
Bin U0	x	0.362	0.360	0.344	0.346
	y	0.372	0.357	0.344	0.359
Bin VN	x	0.329	0.329	0.347	0.346
	y	0.345	0.357	0.372	0.359
Bin V0	x	0.329	0.329	0.346	0.344
	y	0.331	0.345	0.359	0.344
Bin WN	x	0.329	0.316	0.315	0.329
	y	0.345	0.333	0.344	0.357
Bin W0	x	0.329	0.329	0.317	0.316
	y	0.345	0.331	0.320	0.333
Bin XN	x	0.305	0.303	0.315	0.316
	y	0.322	0.333	0.344	0.333
Bin X0	x	0.308	0.305	0.316	0.317
	y	0.311	0.322	0.333	0.320
Bin YO	x	0.308	0.283	0.274	0.303
	y	0.311	0.284	0.301	0.333

Tolerance: ± 0.01

Neutral White	Color Limits (Chromaticity Coordinates)				
Bin R1	x	0.414	0.409	0.392	0.397
	y	0.414	0.400	0.391	0.406
Bin R0	x	0.392	0.387	0.402	0.409
	y	0.391	0.374	0.382	0.400
Bin S1	x	0.397	0.392	0.378	0.382
	y	0.406	0.391	0.382	0.397
Bin S0	x	0.392	0.387	0.374	0.378
	y	0.391	0.374	0.366	0.382
Bin TN	x	0.382	0.378	0.362	0.365
	y	0.397	0.382	0.372	0.386
Bin T0	x	0.378	0.374	0.360	0.362
	y	0.382	0.366	0.357	0.372

Tolerance: ± 0.01

Warm White	Color Limits (Chromaticity Coordinates)				
Bin M1	x	0.460	0.453	0.467	0.473
	y	0.430	0.416	0.419	0.432
Bin M0	x	0.453	0.444	0.459	0.467
	y	0.416	0.399	0.403	0.419
Bin N1	x	0.444	0.438	0.453	0.460
	y	0.426	0.412	0.416	0.430
Bin N0	x	0.438	0.429	0.444	0.453
	y	0.412	0.394	0.399	0.416
Bin P1	x	0.430	0.424	0.438	0.444
	y	0.421	0.407	0.412	0.426
Bin P0	x	0.424	0.416	0.429	0.438
	y	0.407	0.389	0.394	0.412
Bin Q1	x	0.414	0.409	0.424	0.430
	y	0.414	0.400	0.407	0.421
Bin Q0	x	0.409	0.402	0.416	0.424
	y	0.400	0.382	0.389	0.407

Tolerance: ± 0.01

Packaging Option [x5]

Selection	Option
1	Tape and Reel

Example

ASMT-JW33-NSU01

ASMT-JW33-Nxxxx – Cool White, InGaN,
Electrically isolated Heat Sink

- | | |
|-----------|------------------------|
| $X_2 = S$ | – Minimum Flux Bin S |
| $X_3 = U$ | – Maximum Flux Bin U |
| $X_4 = 0$ | – Full Distribution |
| $X_5 = 1$ | – Tape and Reel Option |

Tape and Reel – Option 1

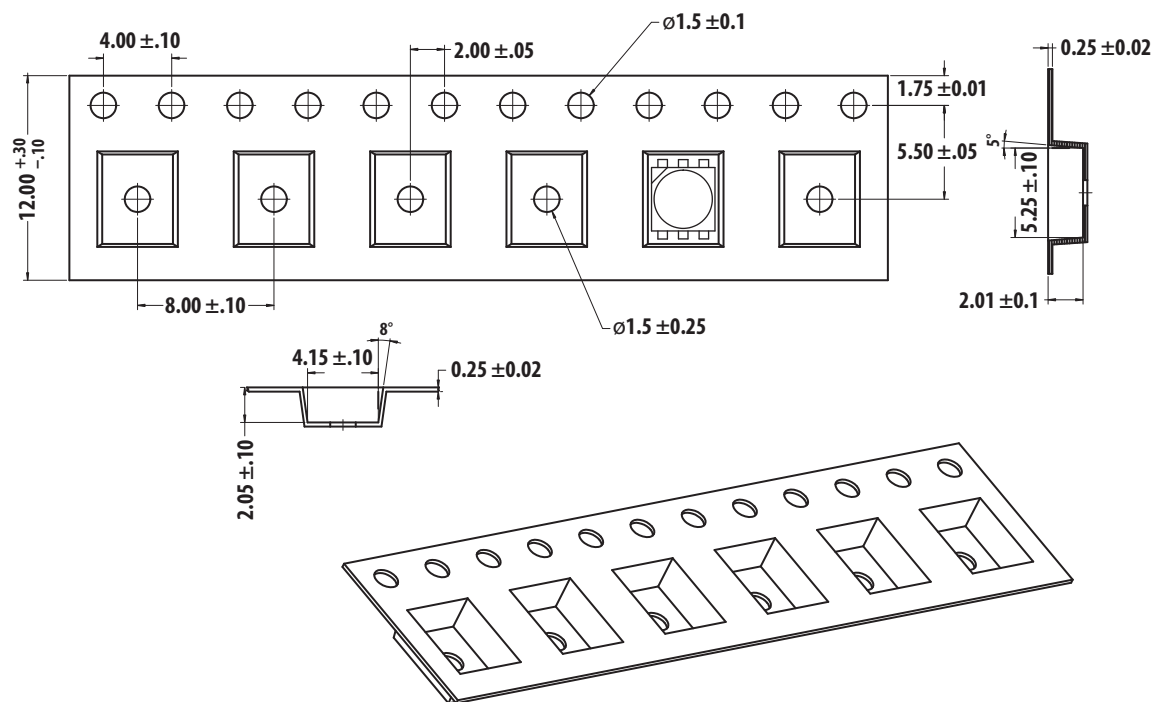
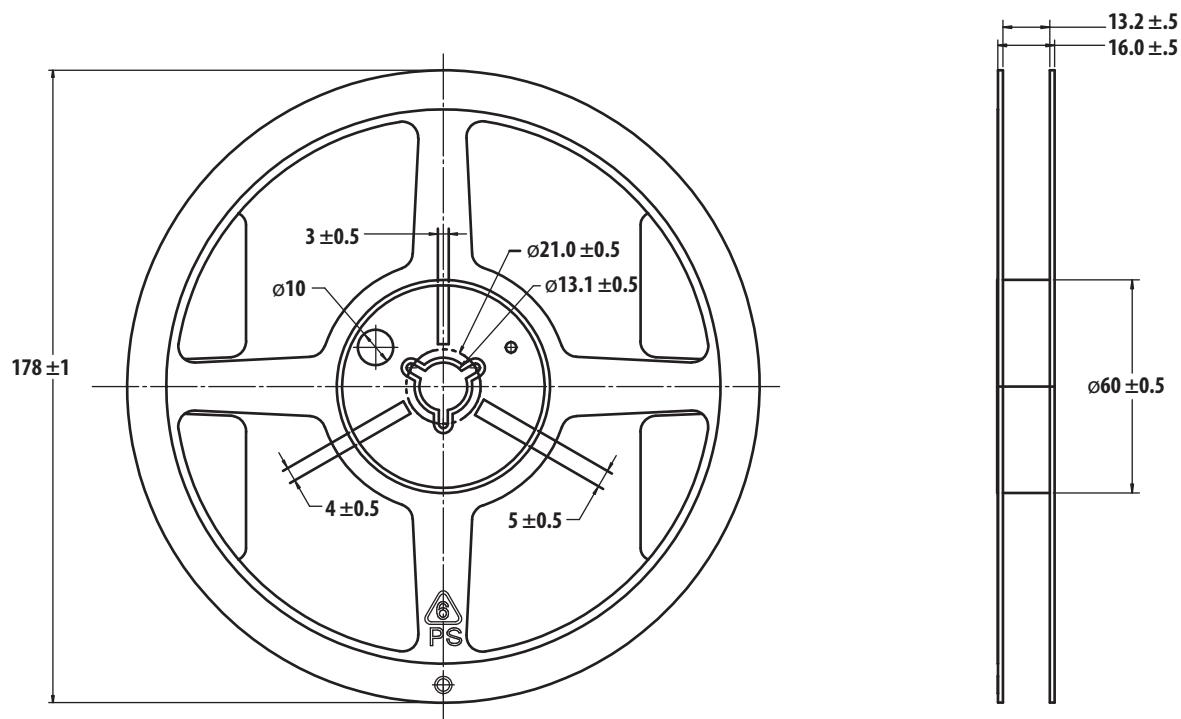


Figure 18. Carrier Tape Dimensions



Notes:

1. Empty component pockets sealed with top cover tape.
2. 250 or 500 pieces per reel.
3. Drawing not to scale.
4. All dimensions are in millimeters.

Figure 19. Reel dimensions

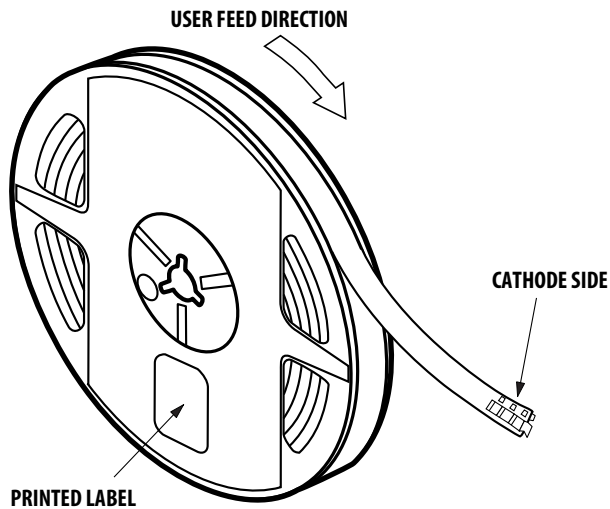


Figure 20. Reeling Orientation

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